



M.E.T. (Metal Etching Technology) has added “electroforming”, an additive process that produces a nickel solder paste stencil, to its manufacturing capabilities. Nickel stencils have been shown to significantly improve paste release in ultra fine pitch applications. In addition to its’ main facility in Lumberton, N.J., M.E.T has also added a second facility in Vadnais Heights, Mn.. Now, with laser cutting, electroforming, and chemical etching processes, M.E.T. can meet any/all of your stencil requirements. For more information visit booth #2756 at the IPC Printed Circuits Expo and Apex show in Los Angeles from February 20th-22<sup>nd</sup>. Or contact Barry R. Goukler, V.P. Sales and Marketing, at: [sales@metassocs.com](mailto:sales@metassocs.com)